TE Internal #: 2-87348-4

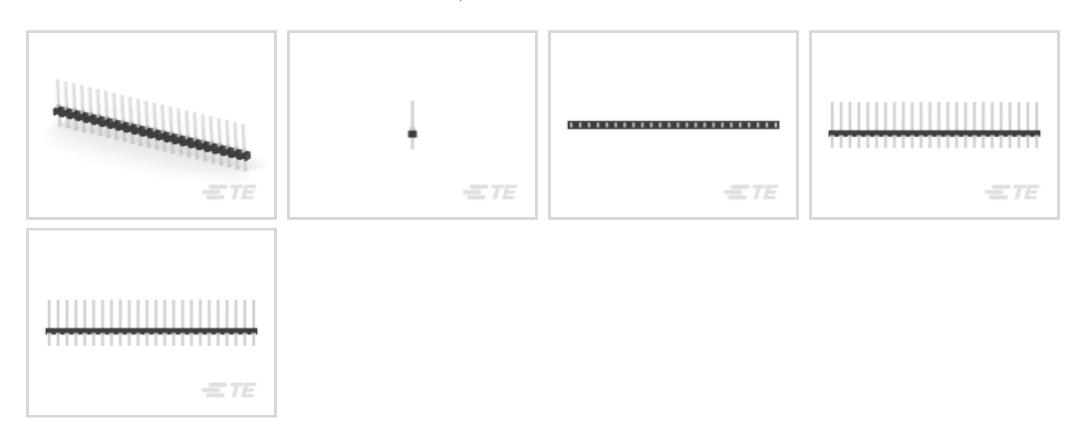
PCB Mount Header, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder,

Signal, Black

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 24

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Unshrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	24
Number of Rows	1
Board-to-Board Configuration	Parallel

Electrical Characteristics

Insulation Resistance	5000 ΜΩ
Dielectric Withstanding Voltage (Max)	750 Vrms



Body Features

Black				
Square				
Bright				
Nickel				
Tin-Lead				
Phosphor Bronze				
Tin-Lead				
2.54 – 5.08 μm[100 – 200 μin]				
Pin				
3 A				
Termination Features				
3.18 mm[.125 in]				
Through Hole - Solder				
Mechanical Attachment				
Without				
Without				
Without				
Board Mount				
2.54 mm[.1 in]				
Nylon-GF				
Dimensions				
1.57 mm[.062 in]				
Standard				
-65 – 105 °C[-85 – 221 °F]				
Board Standoff				
C' I				
Signal				



L	JL Flammability Rating	UL 94V-0				
Pa	Packaging Features					
F	Packaging Type	Carton				

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Customers Also Bought















Documents

Product Drawings

24 MODII HDR SRST UNSHRD .100

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-87348-4_K.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-87348-4_K.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-87348-4_K.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

PCB Mount Header, Vertical, Board-to-Board, 24 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, Signal, Black



Agency Approvals

UL

English